

### FusionServer

# X6000 V6 High-Density Server



## X6000 V6 High-Density Server





X6000 V6 (8 drives)

X6000 V6 (24 drives)

The FusionServer X6000 V6 is a next-generation 2U high-density server that is rearchitected for serving ISP and HPC customers to meet their demands on large-scale server deployment. The servers apply to Internet, high-performance computing (HPC), cloud computing, and data center applications, as well as software-defined storage (SDS), big data, and software-defined infrastructure (SDI).



### Optimal Performance and Ultra-high Density

- 2 times higher computing density than 1U rack servers and 4 times higher than 2U rack servers
- Up to 24 NVMe SSDs



#### **Unified Management and Easy Maintenance**

- The X6000 possesses the advantages of both blade and rack servers. Its server nodes can be centrally managed using the Intelligent Baseboard Management Controller (iBMC). They are installed at the rear, with cables routed from the rear.
- In a modular server structure, drives, nodes, PSUs, OCP cards, and fan modules are hot-swappable.



#### Shared Architecture and High Energy Efficiency

- A chassis supports up to four 3000 W PSUs. Server nodes share the four PSUs in 1+1 or 2+2 redundancy mode.
- Drives do not have midplanes, increasing the heat dissipation capability by 20%.
- The large vapor chamber (VC) conjoined heat sink is capable of phase-change uniform temperature, increasing thermal conductivity by 15 times.

Form Factor	2U 4-node chassis
Server Nodes	Four 1U half-width, 2-socket server nodes
Power Supply Units	Four hot-swappable 1200 W, 1500 W, 2000 W, or 3000 W AC PSUs in 1+1 or 2+2 redundancy mode*
Power Supply	100 V to 240 V AC, 48 V DC (1200 W), 336 V DC (1500 W)
Fan Modules	Four hot-swappable 8080+ fan modules in N+1 redundancy mode
Operating Temperature	5°C to 45°C (41°F to 113°F) (ASHRAE Classes A1 to A3 compliant)
Certifications	CE, UL, FCC, CCC, VCCI and RoHS
Dimensions (H x W x D)	447 mm x 899 mm x 86.1 mm (17.60 in. x 35.39 in. x 3.39 in.)

The X6000 supports 1+1 or 2+2 power redundancy based on the power consumption of the integrated system and a single power supply.

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### XH321 V6 Server Node



The FusionServer XH321 V6 is a next-generation 1U half-width, 2-socket server node. It is that is rearchitected for serving ISP and HPC customers to meet their demands on large-scale server deployment. The servers apply to Internet, high-performance computing (HPC), cloud computing, and data center applications, as well as software-defined storage (SDS), big data, and software-defined infrastructure (SDI).



#### **Superior Computing Performance**

- One or two 3rd Gen Intel® Xeon® Scalable processors, TDP up to 270 W
- 8 DIMMs, 45% higher memory bandwidth
- No I/O bottlenecks, benefiting from all-NVMe SSDs for acceleration and 2+4 balanced configuration



### Flexible Deployment

- InfiniBand HDR 200 high-speed network interconnection
- Two M.2 SSDs to function as high-speed, reliable OS boot drives

Form Factor	1U half-width, 2-socket server node
Processors	two 3rd Gen Intel® Xeon® Scalable processors (6300/8300 series), TDP up to 270 W
Memory	16 DDR4 DIMM slots, up to 2 TB of memory (128 GB DIMM option) at 3200 MT/s
Local Storage	Up to six 2.5" SAS/SATA/SSD/NVMe drives (NVMe SSDs support 2+4 balanced configuration.) One or two M.2 2280 or 2242 SATA SSDs Supports hybrid drive deployments
RAID Support	RAID 0, 1, 5, 6, 10, 50, or 60, and supercapacitor for power failure protection Supports M.2 SSDs in RAID 0 or 1
PCIe Expansion	Two PCIe 4.0 x16 half-height half-length (HHHL) standard expansion slots
OCP Expansion	One OCP expansion slot
Management	<ul> <li>The iBMC chip integrates one dedicated GE management port to provide comprehensive management features such as fault diagnosis, automated O&amp;M, and hardware security hardening.</li> <li>The iBMC supports standard interfaces such as Redfish, SNMP, and IPMI 2.0; provides a remote management user interface based on HTML5/VNC KVM; supports CD-free deployment and the Agentless feature for smart and simplified management.</li> <li>Four compute nodes can be aggregated into one management port to simplify management.</li> <li>(Optional) Configured with the FusionDirector management software to provide advanced management features such as stateless computing, batch OS deployment, and automated firmware upgrade, enabling automatic management throughout the lifecycle.</li> </ul>
Operating Systems	Microsoft Windows Server, SUSE Linux Enterprise Server, VMware ESXi, Red Hat Enterprise Linux, CentOS, Oracle, Ubuntu, Debian, etc
Operating Temperature	5°C to 45°C (41°F to 113°F) (ASHRAE Classes A1 to A3 compliant)
Certifications	CE, UL, FCC, CCC, RoHS, etc
Dimensions (H x W x D)	218.7 mm x 632 mm x 40.7 mm (8.61 in. x 24.88 in. x 1.60 in.)

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# XH321C V6 Liquid-Cooled Server Node



The FusionServer XH321C V6 is a next-generation 1U half-width, 2-socket liquid-cooled server node. It supports liquid cooling (45°C/113°F warm water supported) for CPUs and memory modules. The full liquid cooling solution delivers a heat dissipation ratio of 100% and a power usage effectiveness (PUE) no greater than 1.05. The board-level liquid cooling solution delivers a heat dissipation ratio of 80% and a PUE no greater than 1.1.



#### High Energy Efficiency and Robust Reliability

- The CPU uses a micro-channel cold plate and the memory uses an optimized water routing design for inter-DIMM cold plates. The heat dissipation ratio of board-level liquid cooling reaches 80%.
- The 45°C (113°F) warm water cooling option brings down the TCO by 20%.
- Water flows are isolated from circuits, and their status is monitored in real time.



#### Cabinet-Level Deployment

- Accommodated in a FusionServer liquid cooling cabinet, which has manifolds inside and can be connected to the main pipe.
- Up to 72 liquid-cooled nodes in a liquid cooling cabinet.

Form Factor	1U half-width, 2-socket liquid-cooled server node
Processors	One or two 3rd Gen Intel® Xeon® Scalable processors (6300/8300 series), thermal design power (TDP) up to 270 W
Memory	16 DDR4 DIMM slots, up to 2 TB of memory (128 GB DIMM option) at 3200 MT/s
Local Storage	Up to six 2.5" SAS/SATA/SSD/NVMe drives (NVMe SSDs support 2+4 balanced configuration.) One or two M.2 2280 or 2242 SATA SSDs Supports hybrid drive deployments
RAID Support	RAID 0, 1, 5, 6, 10, 50, or 60, and supercapacitor for power failure protection Supports M.2 SSDs in RAID 0 or 1
PCIe Expansion	One PCle x16 half-height half-length (HHHL) standard expansion slot
OCP Expansion	One OCP expansion slot
Management	<ul> <li>The iBMC chip integrates one dedicated GE management port to provide comprehensive management features such as fault diagnosis, automated O&amp;M, and hardware security hardening.</li> <li>The iBMC supports standard interfaces such as Redfish, SNMP, and IPMI 2.0; provides a remote management user interface based on HTML5/VNC KVM; supports CD-free deployment and the Agentless feature for smart and simplified management.</li> <li>Four compute nodes can be aggregated into one management port to simplify management.</li> <li>(Optional) Configured with the FusionDirector management software to provide advanced management features such as stateless computing, batch OS deployment, and automated firmware upgrade, enabling automatic management throughout the lifecycle.</li> </ul>
Operating Systems	Microsoft Windows Server, Red Hat Enterprise Linux, SUSE Linux Enterprise Server, CentOS, Citrix XenServer, VMware ESXi, etc
Operating Temperature	5°C to 45°C (41°F to 113°F) (ASHRAE Classes A1 to A3 compliant)
Certifications	CE, UL, CCC, VCCI, RoHS, etc
Dimensions (H x W x D)	218.7 mm x 632 mm x 40.7 mm (8.61 in. x 24.88 in. x 1.60 in.) (excluding the water inlet and outlet pipes for liquid cooling)

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